

MATERIAL NUMBER ASSIGNMENT

73782-* * 0 0

NUMBER	CIRCUIT SIZE	DIM "A"	DIM "B"	DIM "C"
0	72	27.6	22.00	2.0
1	144	51.6	46.00	2.0
3	144	51.6	46.00	2.5
4	72	27.6	22.00	3.0
5	144	51.6	46.00	3.0
7	144	51.6	46.00	3.5

NUMBER	DIM "H"	PACKAGING SPECIFICATION
1	15.05	PK-70873-1873
2	6.05	PK-70873-0875
3	10.05	PK-70873-0871

PRE-RELEASE
REFERENCE
USE ONLY

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS	SCALE		CURRENT REV DESC: REMOVED OBSOLETE PART NUMBER AS PER PCN#511698.				molex					
mm	1:1											
GENERAL TOLERANCES (UNLESS SPECIFIED)												
	MM	INCH										
4 PLACES	±		±	EC NO: 742551 DRWN: SANTHN 2023/03/30 CHK'D: GGA 2023/05/12 APPR: GGA 2023/05/12				SALES ASSEMBLY, HDM BACKPLANE STACKING MOD CLOSED END SOLDER				
3 PLACES	±		±									
2 PLACES	±	0.05	±									
1 PLACE	±	0.1	±									
0 PLACES	±		±	INITIAL REVISION: DRWN: JBINGHAM 1997/04/25 APPR: CBIXLER 1997/04/25				DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION
ANGULAR TOL ± 0.5 °			SD-73782-001					PSD	001	J		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			THIRD ANGLE PROJECTION	DRAWING	SERIES	MATERIAL NUMBER	CUSTOMER		SHEET NUMBER			
				C-SIZE	73782	SEE SHEET 2	GENERAL MARKET		2 OF 2			